

MAXIM

Smallest TEC Power Drivers for Optical Modules

General Description

The MAX8520/MAX8521 are designed to drive thermoelectric coolers (TECs) in space-constrained optical modules. Both devices deliver $\pm 1.5A$ output current and control the TEC current to eliminate harmful current surges. On-chip FETs minimize external components and high switching frequency reduces the size of external components.

The MAX8520 and MAX8521 operate from a single supply and bias the TEC between the outputs of two synchronous buck regulators. This operation allows for temperature control without "dead zones" or other nonlinearities at low current. This arrangement ensures that the control system does not hunt when the set point is very close to the natural operating point, requiring a small amount of heating or cooling. An analog control signal precisely sets the TEC current.

Both devices feature accurate, individually adjustable heating current limit and cooling current limit, along with maximum TEC voltage limit to improve the reliability of optical modules. An analog output signal monitors the TEC current. A unique ripple cancellation scheme helps reduce noise.

The MAX8520 is available in a 5mm x 5mm thin QFN package and its switching frequency is adjustable up to 1MHz through an external resistor. The MAX8521 is also available in a 5mm x 5mm thin QFN, as well as a space-saving 3mm x 3mm UCSP™, with a pin-selectable switching frequency of 500kHz or 1MHz.

Applications

SFF/SFP Modules
Fiber-Optic Laser Modules
Fiber-Optic Network Equipment
ATE
Biotech Lab Equipment

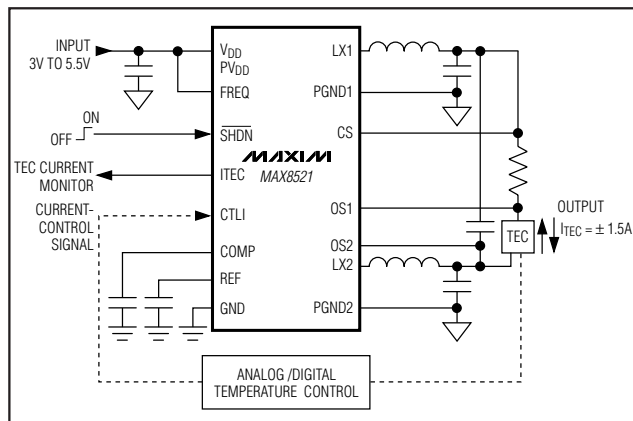
Features

- ◆ Circuit Footprint of 0.31in²
- ◆ Low-Profile Design
- ◆ On-Chip Power MOSFETs
- ◆ High-Efficiency Switch-Mode Design
- ◆ Ripple Cancellation for Low Noise
- ◆ Direct Current Control Prevents TEC Current Surges
- ◆ 5% Accurate Adjustable Heating/Cooling Current Limits
- ◆ 2% Accurate TEC Voltage Limit
- ◆ No Dead Zone or Hunting at Low Output Current
- ◆ ITEC Monitors TEC Current
- ◆ 1% Accurate Voltage Reference
- ◆ Switching Frequency Up to 1MHz
- ◆ Synchronization (MAX8521)

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX8520ETP	-40°C to +85°C	20 Thin QFN 5mm x 5mm
MAX8521EBX	-40°C to +85°C	36 UCSP 3mm x 3mm
MAX8521ETP	-40°C to +85°C	20 Thin QFN 5mm x 5mm

Typical Operating Circuit



Pin Configurations appear at end of data sheet.

UCSP is a trademark of Maxim Integrated Products, Inc.



Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

MAX8520/MAX8521

EVALUATION KIT
AVAILABLE

Smallest TEC Power Drivers for Optical Modules

ABSOLUTE MAXIMUM RATINGS

V _{DD} to GND	-0.3V to +6V
SHDN, MAXV, MAXIP, MAXIN, CTLI to GND	-0.3V to +6V
COMP, FREQ, OS1, OS2, CS, REF, ITEC to GND	-0.3V to (V _{DD} + 0.3V)
PV _{DD} 1, PV _{DD} 2 to GND	-0.3V to (V _{DD} + 0.3V)
PV _{DD} 1, PV _{DD} 2 to V _{DD}	-0.3V to +0.3V
PGND1, PGND2 to GND	-0.3V to +0.3V
COMP, REF, ITEC Short to GND	Indefinite
LX Current (Note 1)	±2.25A LX Current

Continuous Power Dissipation (T _A = +70°C)	
20-Pin 5mm x 5mm x 0.9mm QFN (derate 20.8mW/°C above +70°C) (Note 2)	1.67W
3mm x 3mm UCSP (derate 22mW/°C above +70°C)	1.75W
Maximum Junction Temperature	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (soldering 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 1: LX has internal clamp diodes to PGND and PVDD. Applications that forward bias these diodes should take care not to exceed the IC's package power dissipation limits.

Note 2: Solder underside metal slug to PC board ground plane.

ELECTRICAL CHARACTERISTICS

(V_{DD} = PV_{DD}1 = PV_{DD}2 = $\overline{\text{SHDN}}$ = 5V, 1MHz mode (Note 3). PGND1 = PGND2 = GND, CTLI = MAXV = MAXIP = MAXIN = REF, T_A = 0°C to +85°C, unless otherwise noted. Typical values at T_A = +25°C.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Input Supply Range	V _{DD}			3.0		5.5	V
Maximum TEC Current				±1.5			A
Reference Voltage	V _{REF}	V _{DD} = 3V to 5.5V, I _{REF} = 150μA		1.485	1.5	1.515	V
Reference Load Regulation	ΔV _{REF}	V _{DD} = 3V to 5V, I _{REF} = 10μA to 1mA			1.2	5.0	mV
MAXIP/MAXIN Threshold Accuracy		V _{DD} = 5V	V _{MAXI_} = V _{REF}	140	150	160	mV
			V _{MAXI_} = V _{REF} /3	40	50	60	
		V _{DD} = 3V	V _{MAXI_} = V _{REF}	143	150	155	
			V _{MAXI_} = V _{REF} /3	45	50	55	
NFET On-Resistance	R _{DS(ON-N)}	V _{DD} = 5V, I = 0.2A			0.09	0.14	Ω
		V _{DD} = 3V, I = 0.2A			0.11	0.16	
PFET On-Resistance	R _{DS(ON-P)}	V _{DD} = 5V, I = 0.2A			0.14	0.23	Ω
		V _{DD} = 3V, I = 0.2A			0.17	0.30	
NFET Leakage	I _{LEAK(N)}	V _{LX} = V _{DD} = 5V, T _A = +25°C			0.03	4	μA
		V _{LX} = V _{DD} = 5V, T _A = +85°C			0.3		
PFET Leakage	I _{LEAK(P)}	V _{LX} = 0, T _A = +25°C			0.03	4	μA
		V _{LX} = 0, T _A = +85°C			0.3		
No-Load Supply Current	I _{DD(NO LOAD)}	V _{COMP} = V _{REF} = 1.500V, V _{DD} = 5V	500kHz mode		11	14	mA
			1MHz mode		16	21	
		V _{COMP} = V _{REF} = 1.500V, V _{DD} = 3.3V	500kHz mode		8	11	
			1MHz mode		11	14	
Shutdown Supply Current	I _{DD-SD}	SHDN = GND, V _{DD} = 5V (Note 4)			2	3	mA
Thermal Shutdown	T _{SHUTDOWN}	Hysteresis = 15°C			+165		°C
UVLO Threshold	V _{UVLO}	V _{DD} rising		2.50	2.65	2.80	V
		V _{DD} falling		2.40	2.55	2.70	

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MAX8520/MAX8521

ELECTRICAL CHARACTERISTICS (continued)

($V_{DD} = PV_{DD1} = PV_{DD2} = \overline{SHDN} = 5V$, 1MHz mode (Note 3). $PGND1 = PGND2 = GND$, $CTLI = MAXV = MAXIP = MAXIN = REF$, $T_A = 0^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted. Typical values at $T_A = +25^{\circ}C$.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Internal Oscillator Switching Frequency	f _{SW-INT}	MAX8521, FREQ = V_{DD} , $V_{DD} = 3V$ to $5V$	0.8	1	1.2	MHz
		MAX8521, FREQ = 0, $V_{DD} = 3V$ to $5V$	0.4	0.5	0.6	
		MAX8520, R _{EXT} = $60k\Omega$, $V_{DD} = 5V$	0.8	1	1.2	
		MAX8520, R _{EXT} = $60k\Omega$, $V_{DD} = 3V$	0.76	0.93	1.10	
		MAX8520, R _{EXT} = $150k\Omega$, $V_{DD} = 5V$	0.4	0.5	0.6	
		MAX8520, R _{EXT} = $150k\Omega$, $V_{DD} = 3V$	0.36	0.46	0.56	
External Sync Frequency Range		25% < duty cycle < 75% (MAX8521 only)	0.7		1.2	MHz
LX_ Duty Cycle		(Note 5)	0		100	%
OS1, OS2, CS Input Current	I _{OS1} , I _{OS2} , I _{CS}	0 or V_{DD}	-100		+100	μA
$\overline{SHDN}$, FREQ Input Current	I _{SHDN} , I _{FREQ}	0 or V_{DD} , FREQ applicable for the MAX8521 only	-5		+5	μA
$\overline{SHDN}$, FREQ Input Low Voltage	V _{IL}	$V_{DD} = 3V$ to $5.5V$, FREQ applicable for the MAX8521 only			$V_{DD} \times 0.25$	V
$\overline{SHDN}$, FREQ Input High Voltage	V _{IH}	$V_{DD} = 3V$ to $5.5V$, FREQ applicable for the MAX8521 only	$V_{DD} \times 0.75$			V
MAXV Threshold Accuracy		$V_{MAXV} = V_{REF} \times 0.67$, V_{OS1} to $V_{OS2} = \pm 4V$, $V_{DD} = 5V$	-2		+2	%
		$V_{MAXV} = V_{REF} \times 0.33$, V_{OS1} to $V_{OS2} = \pm 2V$, $V_{DD} = 3V$	-3		+3	%
MAXV, MAXI_ Input Bias Current	I _{MAXV-BIAS} , I _{MAXI_-BIAS}	$V_{MAXV} = V_{MAXI_-} = 0.1V$ or $1.5V$	-0.1		+0.1	μA
CTLI Gain	A _{CTLI}	$V_{CTLI} = 0.5V$ to $2.5V$ (Note 6)	9.5	10	10.5	V/V
CTLI Input Resistance	R _{CTLI}	$1M\Omega$ terminated at REF	0.5	1	2.0	$M\Omega$
Error-Amp Transconductance	g _m		50	100	160	μS
VITEC Accuracy		V_{OS1} to $V_{CS} = \pm 100mV$, $V_{OS1} = V_{DD}/2$	-10		+10	%

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ELECTRICAL CHARACTERISTICS

($V_{DD} = PV_{DD1} = PV_{DD2} = \overline{SHDN} = 5V$, 1MHz mode (Note 2). PGND1 = PGND2 = GND, CTLI = MAXV = MAXIP = MAXIN = REF, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted.) (Note 7)

PARAMETER	SYMBOL	CONDITIONS		MIN	MAX	UNITS
Input Supply Range	V _{DD}			3.0	5.5	V
Maximum TEC Current				±1.5		A
Reference Voltage	V _{REF}	V _{DD} = 3V to 5.5V, I _{REF} = 150μA		1.480	1.515	V
Reference Load Regulation	ΔV _{REF}	V _{DD} = 3V to 5V, I _{REF} = 10μA to 1mA		5		mV
MAXIP/MAXIN Threshold Accuracy		V _{DD} = 5V	V _{MAXI_} = V _{REF}	140	160	mV
			V _{MAXI_} = V _{REF} /3	40	60	
		V _{DD} = 3V	V _{MAXI_} = V _{REF}	143	155	
			V _{MAXI_} = V _{REF} /3	45	55	
NFET On-Resistance	R _{DS(ON-N)}	V _{DD} = 5V, I = 0.2A		0.14		Ω
		V _{DD} = 3V, I = 0.2A		0.16		
PFET On-Resistance	R _{DS(ON-P)}	V _{DD} = 5V, I = 0.2A		0.23		Ω
		V _{DD} = 3V, I = 0.2A		0.30		
No-Load Supply Current	I _{DD(NO LOAD)}	V _{COMP} = V _{REF} = 1.500V, V _{DD} = 5V	500kHz mode	14		mA
			1MHz mode	21		
		V _{COMP} = V _{REF} = 1.500V, V _{DD} = 3.3V	500kHz mode	11		
			1MHz mode	14		
Shutdown Supply Current	I _{DD-SD}	SHDN = GND, V _{DD} = 5V (Note 4)		3		mA
UVLO Threshold	V _{UVLO}	V _{DD} rising		2.50	2.80	V
		V _{DD} falling		2.40	2.70	
Internal Oscillator Switching Frequency	f _{SW-INT}	MAX8521, FREQ = V _{DD} , V _{DD} = 3V to 5V		0.8	1.2	MHz
		MAX8521, FREQ = 0, V _{DD} = 3V to 5V		0.4	0.6	
		MAX8520, R _{EXT} = 60kΩ, V _{DD} = 5V		0.8	1.2	
		MAX8520, R _{EXT} = 60kΩ, V _{DD} = 3V		0.76	1.10	
		MAX8520, R _{EXT} = 150kΩ, V _{DD} = 5V		0.4	0.6	
		MAX8520, R _{EXT} = 150kΩ, V _{DD} = 3V		0.36	0.56	
External Sync Frequency Range		25% < duty cycle < 75% (MAX8521 only)		0.7	1.2	MHz
LX_ Duty Cycle		(Note 5)		0	100	%
OS1, OS2, CS Input Current	I _{OS1} , I _{OS2} , I _{CS}	0 or V _{DD}		-100	+100	μA
SHDN, FREQ Input Current	I _{SHDN} , I _{FREQ}	0 or V _{DD} , FREQ applicable for the MAX8521 only		-5	+5	μA
SHDN, FREQ Input Low Voltage	V _{IL}	V _{DD} = 3V to 5.5V, FREQ applicable for the MAX8521 only		V _{DD} × 0.25		V
SHDN, FREQ Input High Voltage	V _{IH}	V _{DD} = 3V to 5.5V, FREQ applicable for the MAX8521 only		V _{DD} × 0.75		V

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MAX8520/MAX8521

ELECTRICAL CHARACTERISTICS (continued)

($V_{DD} = PV_{DD1} = PV_{DD2} = \overline{SHDN} = 5V$, 1MHz mode (Note 2). PGND1 = PGND2 = GND, CTLI = MAXV = MAXIP = MAXIN = REF, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted.) (Note 7)

PARAMETER	SYMBOL	CONDITIONS	MIN	MAX	UNITS
MAXV Threshold Accuracy		$V_{MAXV} = V_{REF} \times 0.67$, V_{OS1} to $V_{OS2} = \pm 4V$, $V_{DD} = 5V$	-2	+2	%
		$V_{MAXV} = V_{REF} \times 0.33$, V_{OS1} to $V_{OS2} = \pm 2V$, $V_{DD} = 3V$	-3	+3	%
MAXV, MAXI_ Input Bias Current	$I_{MAXV-BIAS}$, I_{MAXI_-BIAS}	$V_{MAXV} = V_{MAXI_-} = 0.1V$ or $1.5V$	-0.1	+0.1	μA
CTLI Gain	A_{CTLI}	$V_{CTLI} = 0.5V$ to $2.5V$ (Note 6)	9.5	10.5	V/V
CTLI Input Resistance	R_{CTLI}	$1M\Omega$ terminated at REF	0.5	2.0	$M\Omega$
Error-Amp Transconductance	g_m		50	160	μS
VITEC Accuracy		V_{OS1} to $V_{CS} = \pm 100mV$, $V_{OS1} = V_{DD}/2$	-10	+10	%

Note 3: Enter 1MHz mode by tying a $60k\Omega$ resistor from FREQ to ground for the MAX8520, and tying FREQ to V_{DD} for the MAX8521.

Note 4: Includes PFET leakage.

Note 5: Duty-cycle specification is guaranteed by design and not production tested.

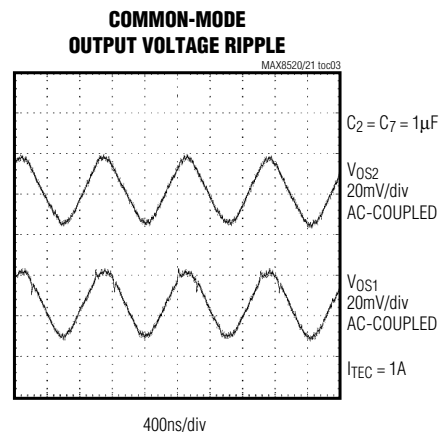
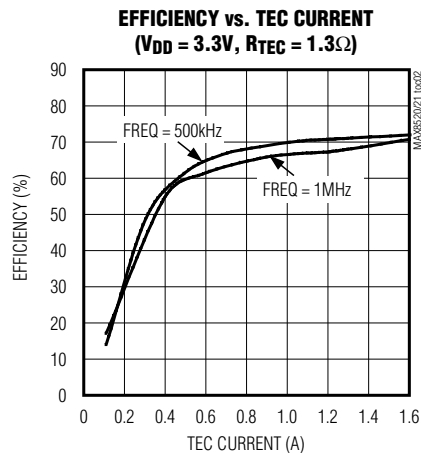
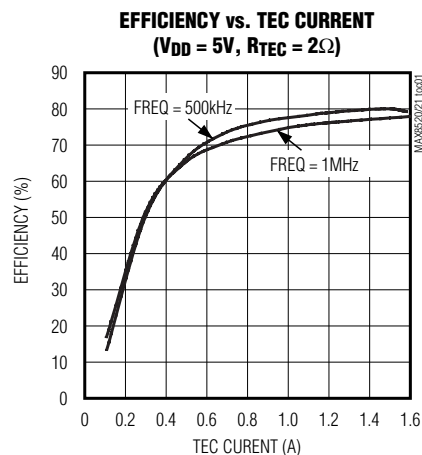
Note 6: CTLI Gain is defined as:

$$A_{CTLI} = \frac{\Delta V_{CTLI}}{\Delta(V_{OS1} - V_{CS})}$$

Note 7: Specifications to $-40^{\circ}C$ are guaranteed by design and not production tested.

Typical Operating Characteristics

($V_{DD} = 5V$, circuit of Figure 1, $T_A = +25^{\circ}C$, unless otherwise noted)

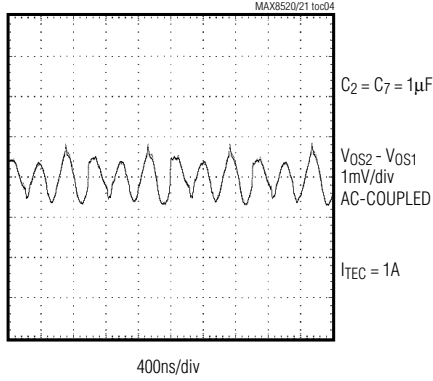


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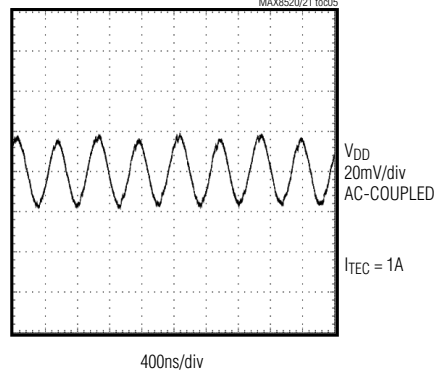
Typical Operating Characteristics (continued)

($V_{DD} = 5V$, circuit of Figure 1, $T_A = +25^\circ C$, unless otherwise noted)

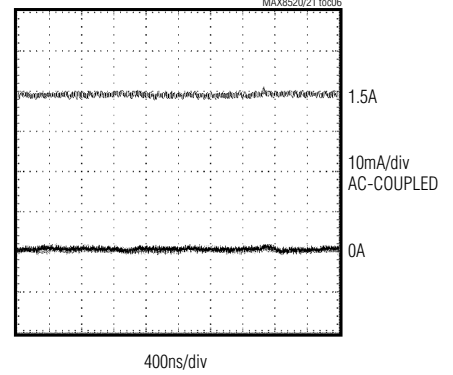
**DIFFERENTIAL
OUTPUT VOLTAGE RIPPLE**



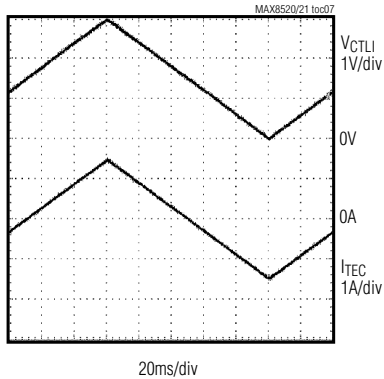
V_{DD} RIPPLE



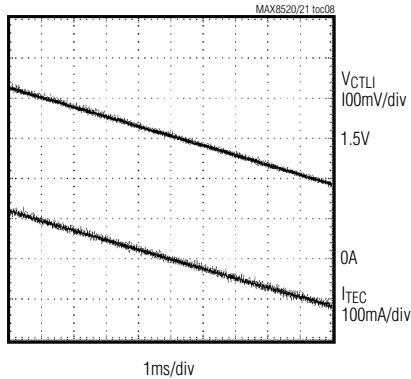
TEC CURRENT RIPPLE



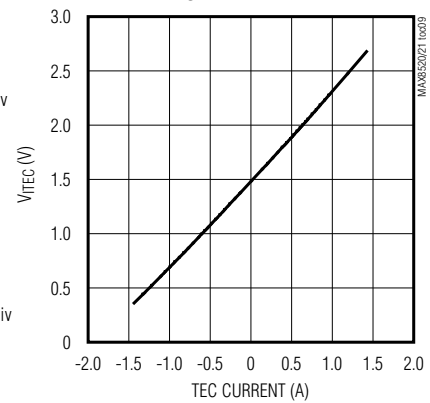
TEC CURRENT vs. CTLI VOLTAGE



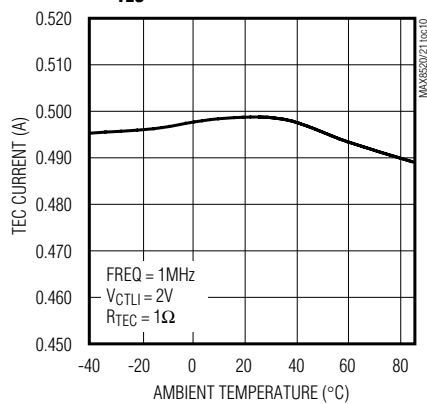
ZERO-CROSSING TEC CURRENT



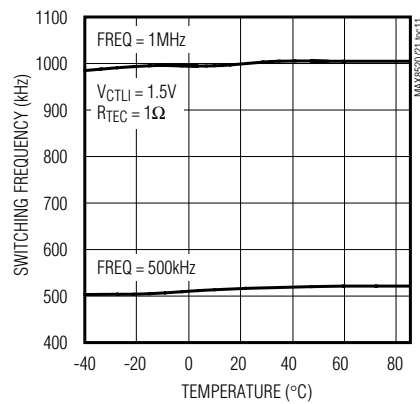
V_{ITEC} vs. TEC CURRENT



I_{TEC} vs. AMBIENT TEMPERATURE



**SWITCHING FREQUENCY
vs. TEMPERATURE**

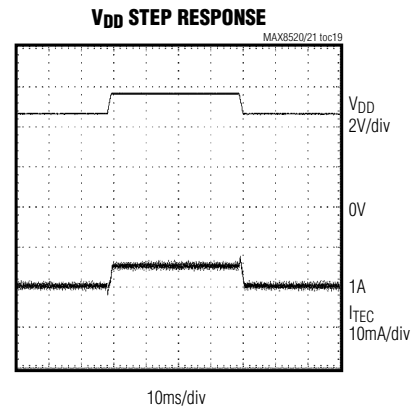
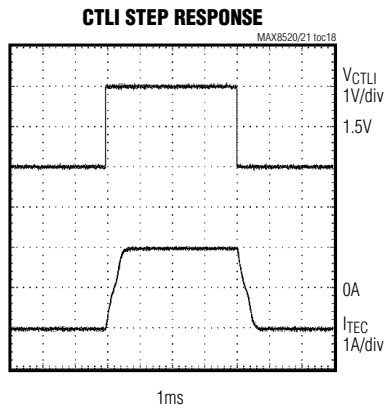
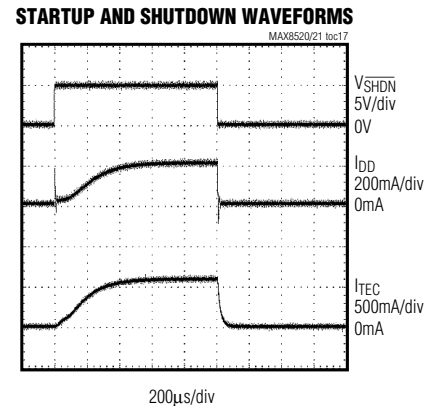
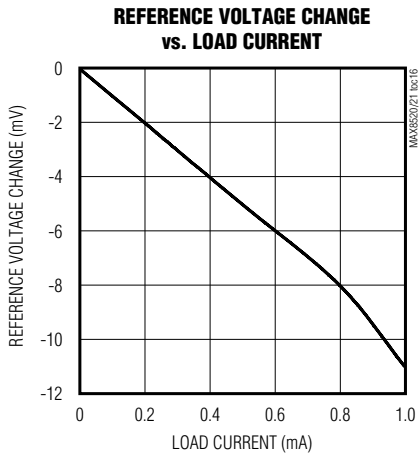
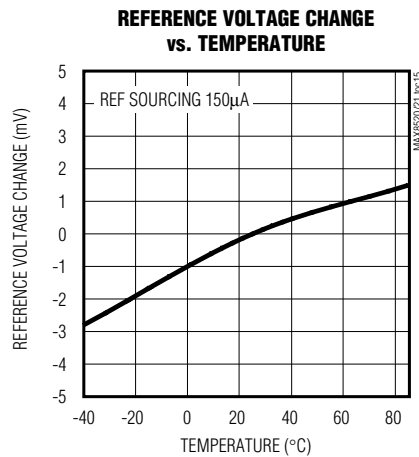
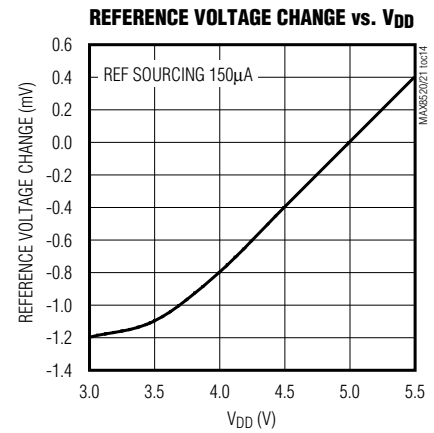
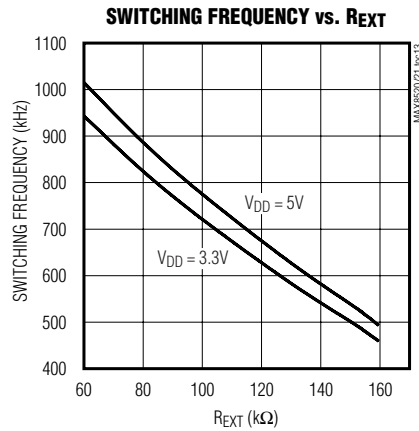
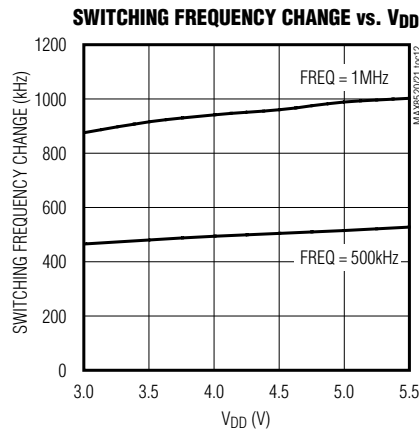


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Typical Operating Characteristics (continued)

($V_{DD} = 5V$, circuit of Figure 1, $T_A = +25^\circ C$ unless otherwise noted)

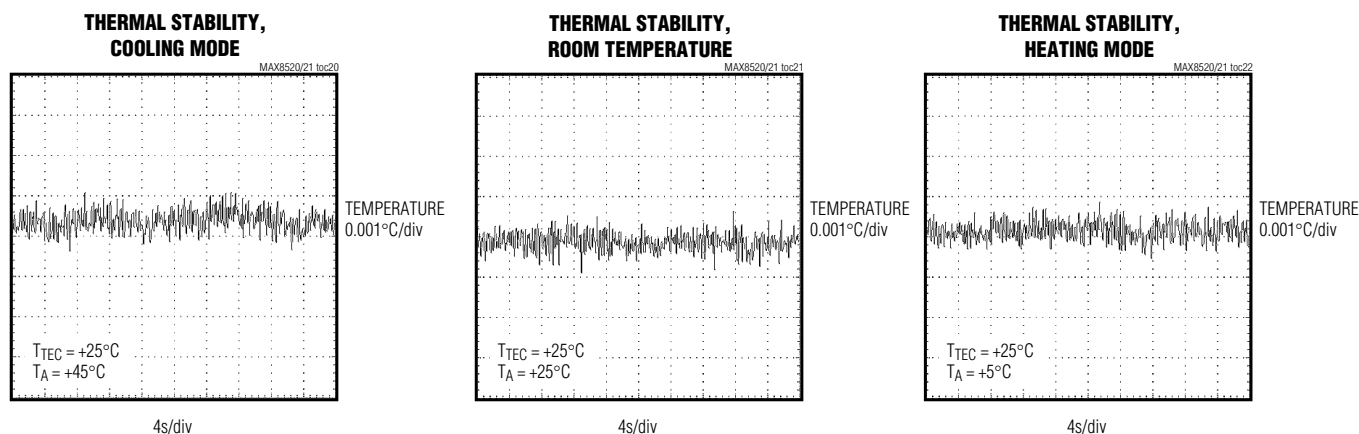
MAX8520/MAX8521



Smallest TEC Power Drivers for Optical Modules

Typical Operating Characteristics (continued)

($V_{DD} = 5V$, circuit of Figure 1, $T_A = +25^\circ C$ unless otherwise noted)



Pin Description

PIN		NAME	FUNCTION
QFN	UCSP		
1	E1, E2	LX1	Inductor Connection. LX1 is high-impedance in shutdown.
2	D1, D2, D3	PGND1	Power Ground 1. Internal synchronous-rectifier ground connection. Connect all PGND pins together at power ground plane.
3	C1	$\overline{SHDN}$	Shutdown Control Input. Pull $\overline{SHDN}$ low to turn off PWM control and ITEC output.
4	C2	COMP	Current-Control Loop Compensation. Refer to the <i>Compensation Capacitor</i> section.
5	B1	ITEC	TEC Current-Monitor Output. The ITEC output voltage is a function of the voltage across the TEC current-sense resistor. $V_{ITEC} = V_{REF} + 8(V_{OS} - V_{CS})$. Keep capacitance on ITEC < 150pF.
6	A1	MAXIN	Maximum Negative TEC Current. Connect MAXIN to REF to set default negative current limit to $-150mV/R_{SENSE}$. To lower this current limit, connect MAXIN to a resistor divider network from REF to GND. The current limit will then be equal to $-(V_{MAXIN}/V_{REF}) \times (150mV/R_{SENSE})$.
7	A2	MAXIP	Maximum Positive TEC Current. Connect MAXIP to REF to set default positive current limit to $150mV/R_{SENSE}$. To lower this current limit, connect MAXIP to a resistor divider network from REF to GND. The current limit will then be equal to $(V_{MAXIP}/V_{REF}) \times (150mV/R_{SENSE})$.
8	A3	MAXV	Maximum Bipolar TEC Voltage. Connect MAXV to REF to set default maximum TEC voltage to V_{DD} . To lower this limit, connect MAXV to a resistor-divider network from REF to GND. The maximum TEC voltage is equal to $4 \times V_{MAXV}$ or V_{DD} , whichever is lower.
9	A4	REF	1.50V Reference Output. Bypass REF to GND with a 0.1μF ceramic capacitor.

Smallest TEC Power Drivers for Optical Modules

Pin Description (continued)

MAX8520/MAX8521

PIN		NAME	FUNCTION
QFN	UCSP		
10	A5	CTLI	TEC Current-Control Input. Sets TEC current. Center point is 1.50V (no TEC current). The current is given by: $I_{TEC} = (V_{OS1} - V_{CS}) / R_{SENSE} = (V_{CTLI} - 1.50) / (10 \times R_{SENSE})$ When $(V_{CTLI} - V_{REF}) > 0$, then $V_{OS2} > V_{OS1} > V_{CS}$.
11	A6	GND	Analog Ground. Start connect to PGND at underside exposed pad for QFN package.
12	B6	VDD	Analog Supply Voltage Input. Bypass VDD to GND with a 1μF ceramic capacitor.
13	C5	FREQ	For MAX8520: Analog FREQ Set Pin (see the <i>Switching Frequency</i> section).
			For MAX8521: Digital FREQ Selection Pin. Tie to VDD for 1MHz operation, tie to GND for 500kHz operation. The PWM oscillator can synchronize to FREQ by switching at FREQ between 700kHz and 1.2MHz.
14	D4, D5, D6	PGND2	Power Ground 2. Internal synchronous rectifier ground connection. Connect all PGND pins together at the power ground plane.
15	E5, E6	LX2	Inductor Connection. LX2 is high impedance in shutdown.
16	F5, F6	PVDD2	Power Input 2. Connect all PVDD inputs together at the VDD power plane.
17	F4	CS	Current-Sense Input. The current through the TEC is monitored between CS and OS1. The maximum TEC current is given by $150mV/R_{SENSE}$ and is bipolar.
18	C6	OS2	Output Sense 2. OS2 senses one side of the differential TEC voltage. OS2 is a sense point, not a power output. OS2 discharges to ground in shutdown.
19	F3	OS1	Output Sense 1. OS1 senses one side of the differential TEC voltage. OS1 is a sense point, not a power output. OS1 discharges to ground in shutdown.
20	F1, F2	PVDD1	Power Input 1. Connect all PVDD inputs together at the VDD power plane.
	B2, B5, C3, C4	GND2	Ground. Additional ground pads aid in heat dissipation. Short to either GND or PGND plane.
	B3, B4 E3, E4	N.C.	No Connect. Connect no-connect pads to GND2 to aid in heat dissipation.

Smallest TEC Power Drivers for Optical Modules

Detailed Description

The MAX8520/MAX8521 TEC drivers consist of two switching buck regulators that operate together to directly control the TEC current. This configuration creates a differential voltage across the TEC, allowing bidirectional TEC current for controlled cooling and heating. Controlled cooling and heating allow accurate TEC temperature control to within $\pm 0.01^\circ\text{C}$. The voltage at CTLI directly sets the TEC current. An external thermal-control loop is typically used to drive CTLI. Figures 1 and 2 show examples of the thermal control-loop circuit.

Ripple Cancellation

Switching regulators like those used in the MAX8520/MAX8521 inherently create ripple voltage on the output. The dual regulators in the MAX8520/MAX8521 switch in phase and provide complementary in-phase duty cycles so ripple waveforms at the TEC are greatly reduced. This feature suppresses ripple currents and electrical noise at the TEC to prevent interference with the laser diode.

Switching Frequency

For the MAX8521, FREQ sets the switching frequency of the internal oscillator. With FREQ = GND, the oscillator frequency is set to 500kHz. The oscillator frequency is 1MHz when FREQ = V_{DD}.

For the MAX8520, connect a resistor (R_{EXT} in Figure 2) from FREQ to GND. Choose R_{EXT} = 60k Ω for 1MHz operation, and R_{EXT} = 150k Ω for 500kHz operation. For any intermediary frequency between 500kHz and 1MHz, use the following equation to find the value of R_{EXT} value needed for V_{DD} = 5V:

$$R_{EXT} = 90 \times \left(\frac{1}{f_s} - \frac{1}{3} \right)$$

where R_{EXT} is the resistance given in k Ω , and f_s is the desired frequency given in MHz. Note that for V_{DD} < 5V, the frequency is reduced slightly, to the extent of about 7% when V_{DD} reaches 3V. This should be taken into consideration when selecting the value for R_{EXT} at a known supply voltage.

Voltage and Current-Limit Setting

Both the MAX8520 and MAX8521 provide control of the maximum differential TEC voltage. Applying a voltage to MAXV limits the maximum voltage across the TEC. The voltage at MAXIP and MAXIN sets the maximum positive and negative current through the TEC. These current limits can be independently controlled.

Table 1. TEC Connection for Figure 1

TEC CONNECTION	THERMISTOR
Heating mode	PTC
Cooling mode	NTC

Table 2. TEC Connection for Figure 2

TEC CONNECTION	THERMISTOR
Heating mode	NTC
Cooling mode	PTC

Current Monitor Output

I_{TEC} provides a voltage output proportional to the TEC current (I_{TEC}). See the *Functional Diagram* for more details:

$$V_{ITEC} = 1.5V + (8 \times (V_{OS1} - V_{CS}))$$

Reference Output

The MAX8520/MAX8521 include an on-chip voltage reference. The 1.50V reference is accurate to 1% over temperature. Bypass REF with 0.1 μF to GND. REF can be used to bias an external thermistor for temperature sensing as shown in Figures 1 and 2.

Thermal and Fault-Current Protection

The MAX8520/MAX8521 provide fault-current protection in either FET by turning off both high-side and low-side FETs when the peak current exceeds 3A in either FET. In addition, thermal-overload protection limits the total power dissipation in the chip. When the device's die junction temperature exceeds +165 $^\circ\text{C}$, an on-chip thermal sensor shuts down the device. The thermal sensor turns the device on again after the junction temperature cools down by 15 $^\circ\text{C}$.

Design Procedures

Duty-Cycle Range Selection

By design, the MAX8520/MAX8521 are capable of operating from 0% to 100% duty cycle, allowing both LX outputs to enter dropout. However, as the LX pulse width narrows, accurate duty-cycle control becomes difficult. This can result in a low-frequency noise appearing at the TEC output (typically in the 20kHz to 50kHz range). While this noise is typically filtered out by the low thermal-loop bandwidth, for best results, operate the PWM with a pulse width greater than 200ns. For a 500kHz application, the recommended duty-cycle range is from 10% to 90%. For a 1MHz application, it is from 20% to 80%.

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MAX8520/MAX8521

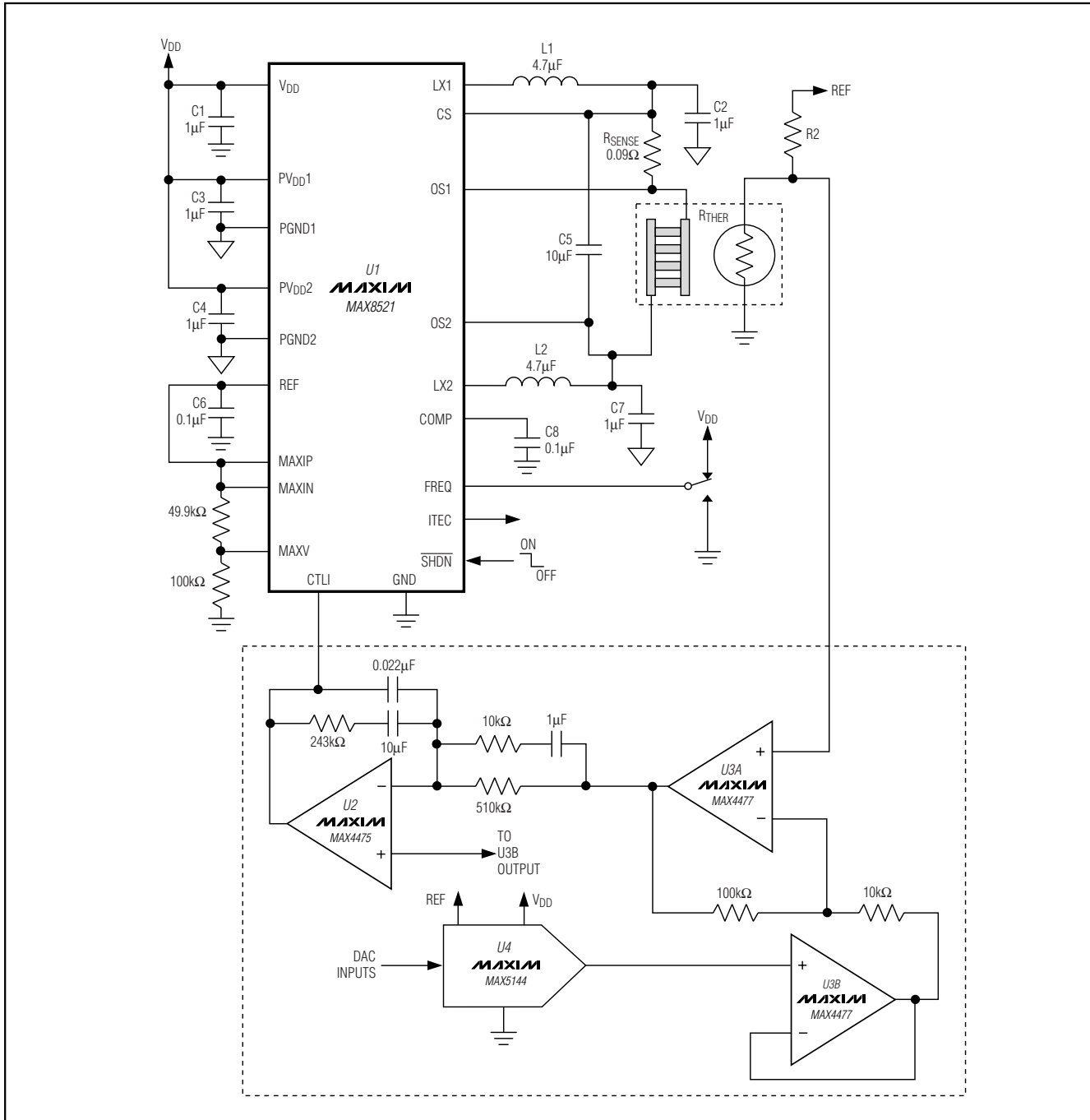


Figure 1. MAX8521 Typical Application Circuit

Smallest TEC Power Drivers for Optical Modules

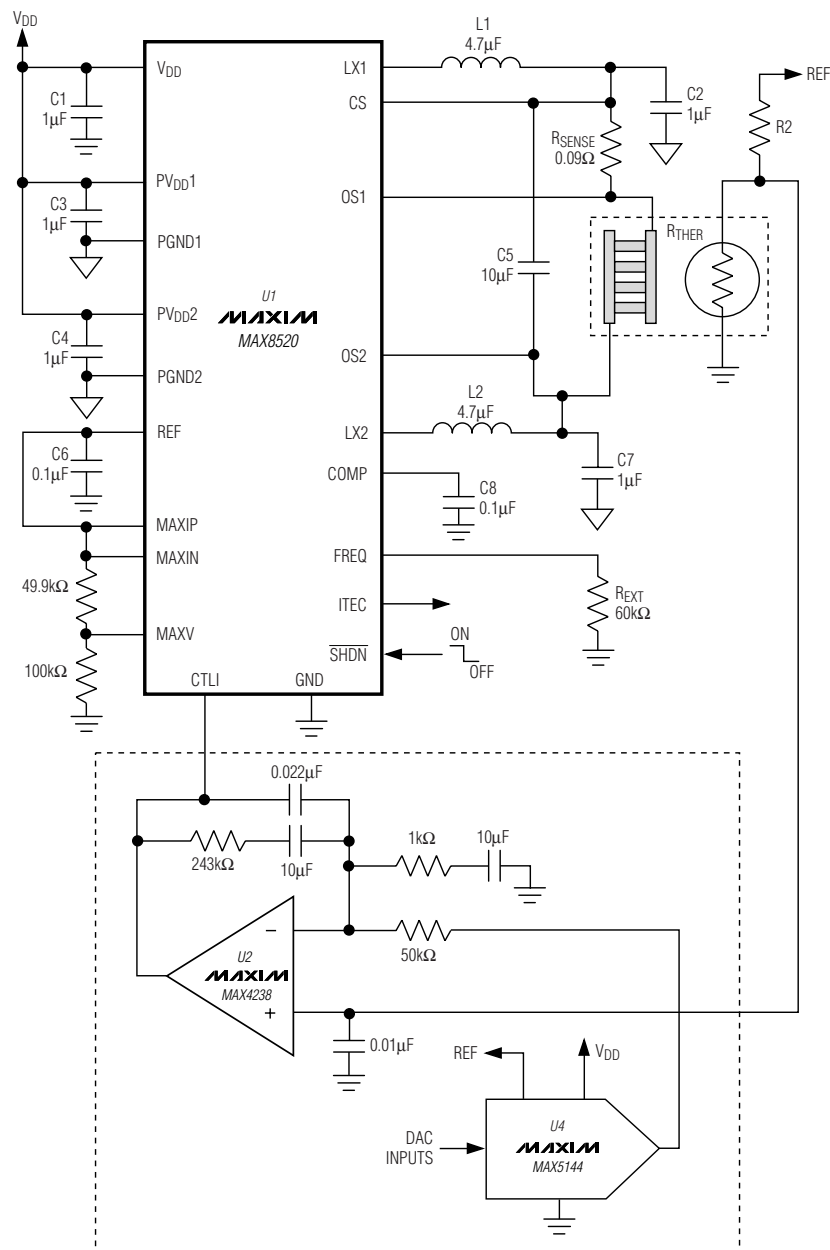


Figure 2. Typical Application Circuit for the MAX8520 with Reduced Op-Amp Count Configuration

MAX8520/MAX8527



The MAX8520/MAX8521 dual buck converters operate in phase and in complementary mode to drive the TEC differentially in a current-mode control scheme. At zero TEC current, the differential voltage is zero; hence, the outputs with respect to GND are equal to half of V_{DD} . As the TEC current demand increases, one output goes up and the other goes down from the initial point of $0.5V_{DD}$ by an amount equal to $0.5 \times V_{TEC}$ ($V_{TEC} = I_{TEC} \times R_{TEC}$). Therefore, the operating duty cycle of each buck converter depends on the operating I_{TEC} and R_{TEC} . Since inductor current calculations for heating and cooling are identical, but reverse in polarity, the calculations only need to be carried out for either one.

Calculate the inductor value as follows:

$$L = \frac{(0.25 \times V_{DD})}{LIR \times I_{TEC(MAX)} \times fs}$$

As an example, for $V_{DD} = 3.3V$, $LIR = 12\%$, and $f_s = 1MHz$, $L = 4.58\mu H$.

Output Filter Capacitor Selection

The common-mode filter capacitors (C2 and C7 of Figure 1) are used as filter capacitors to ground for each output. The output ripple voltage depends on the capacitance, the ESR of these capacitors, and the inductor ripple current. Ceramic capacitors are recommended for their low ESR and impedance at high frequency.

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The output common-mode ripple voltage can be calculated as follows:

$$V_{\text{RIPPLE(P-P)}} = \text{LIR} \times I_{\text{TEC(MAX)}} (\text{ESR} + 1/8 \times C \times f_s)$$

A 1μF ceramic capacitor with ESR of 10mΩ with LIR = 12% and $I_{\text{TEC(MAX)}} = 1.5\text{A}$ results in $V_{\text{RIPPLE(P-P)}}$ of 24.3mV. For size-constraint applications, the capacitor can be made smaller at the expense of higher ripple voltage. However, the capacitance must be high enough so that the LC resonant frequency is less than 1/5 the switching frequency:

$$f = \frac{1}{2\pi\sqrt{LC}}$$

where f is the resonant frequency of the output filter.

Differential Mode Filter Capacitor

The differential-mode filter capacitor (C5 in Figure 1) is used to bypass differential ripple current through the TEC as the result of unequal duty cycle of each output. This happens when the TEC current is not at zero. As TEC current increases from zero, both outputs move away from the 50% duty-cycle point complementarily. The common-mode ripple decreases, but the differential ripple does not cancel perfectly, and there is a resulting differential ripple. The maximum value happens when one output is at 75% duty cycle and the other is at 25% duty cycle. At this operating point, the differential ripple is equal to 1/2 of the maximum common-mode ripple. The TEC ripple current determines the TEC performance, because the maximum temperature differential that can be created between the terminals of the TEC depends on the ratio of ripple current and DC current. The lower the ripple current, the closer to the ideal maximum. The differential-mode capacitor provides a low-impedance path for the ripple current to flow, so that the TEC ripple current is greatly reduced. The TEC ripple current can then be calculated as follows:

$$I_{\text{TEC(RIPPLE)}} = (0.5 \times \text{LIR} \times I_{\text{TEC(MAX)}}) \times (Z_{C5}) / (R_{\text{TEC}} + R_{\text{SENSE}} + Z_{C5})$$

where Z_{C5} is the impedance of C5 at twice the switching frequency, R_{TEC} is the TEC equivalent resistance, and R_{SENSE} is the current-sense resistor.

Decoupling Capacitor Selection

Decouple each power-supply input (V_{DD} , PV_{DD1} , PV_{DD2}) with a 1μF ceramic capacitor close to the supply pins. In applications with long distances between the source supply and the MAX8520/MAX8521, additional

bypassing may be needed to stabilize the input supply. In such cases, a low-ESR electrolytic or ceramic capacitor of 100μF or more at V_{DD} is sufficient.

Compensation Capacitor

A compensation capacitor is needed to ensure current-control-loop stability (see Figure 3). Select the capacitor so that the unity-gain bandwidth of the current-control loop is less than or equal to 10% the resonant frequency of the output filter:

$$C_{\text{COMP}} \geq \left(\frac{g_m}{f_{\text{BW}}} \right) \times \left(\frac{24 \times R_{\text{SENSE}}}{2\pi(R_{\text{SENSE}} \times R_{\text{TEC}})} \right)$$

where:

f_{BW} = unity-gain bandwidth frequency, less than or equal to 10% the output filter resonant frequency

g_m = loop transconductance, typically 100μA/V

C_{COMP} = value of the compensation capacitor

R_{TEC} = TEC series resistance; use the minimum resistance value

R_{SENSE} = sense resistor

Setting Voltage and Current Limits

Certain TEC parameters must be considered to guarantee a robust design. These include maximum positive current, maximum negative current, and the maximum voltage allowed across the TEC. These limits should be used to set the MAXIP, MAXIN, and MAXV voltages.

Setting Max Positive and Negative TEC Current

MAXIP and MAXIN set the maximum positive and negative TEC currents, respectively. The default current limit is $\pm 150\text{mV}/R_{\text{SENSE}}$ when MAXIP and MAXIN are connected to REF. To set maximum limits other than the defaults, connect a resistor-divider from REF to GND to set $V_{\text{MAXI_}}$. Use resistors in the 10kΩ to 100kΩ range. $V_{\text{MAXI_}}$ is related to I_{TEC} by the following equations:

$$V_{\text{MAXIP}} = 10(I_{\text{TECP(MAX)}} \times R_{\text{SENSE}})$$

$$V_{\text{MAXIN}} = 10(I_{\text{TECN(MAX)}} \times R_{\text{SENSE}})$$

where $I_{\text{TECP(MAX)}}$ is the maximum positive TEC current and $I_{\text{TECN(MAX)}}$ is the negative maximum TEC current. Positive TEC current occurs when CS is less than OS1:

$$I_{\text{TEC}} \times R_{\text{SENSE}} = \text{OS1} - \text{CS}$$

when $I_{\text{TEC}} > 0$.

$$I_{\text{TEC}} \times R_{\text{SENSE}} = \text{CS} - \text{OS1}$$

when $I_{\text{TEC}} < 0$.

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Take care not to exceed the positive or negative current limit on the TEC. Refer to the manufacturer's data sheet for these limits.

Setting Max TEC Voltage

Apply a voltage to the MAXV pin to control the maximum differential TEC voltage. MAXV can vary from 0 to REF. The voltage across the TEC is four times V_{MAXV} and can be positive or negative:

$|V_{OS1} - V_{OS2}| = 4 \times V_{MAXV}$ or V_{DD} , whichever is lower
Set V_{MAXV} with a resistor-divider between REF and GND using resistors from 10k Ω to 100k Ω . V_{MAXV} can vary from 0 to REF.

Control Inputs/Outputs

Output Current Control

The voltage at CTLI directly sets the TEC current. CTLI is typically driven from the output of a temperature control loop. The transfer function relating current through the TEC (I_{TEC}) and V_{CTLI} is given by:

$$I_{TEC} = (V_{CTLI} - V_{REF}) / (10 \times R_{SENSE})$$

where V_{REF} is 1.50V and:

$$I_{TEC} = (V_{OS1} - V_{CS}) / R_{SENSE}$$

CTLI is centered around REF (1.50V). I_{TEC} is zero when $CTLI = 1.50V$. When $V_{CTLI} > 1.50V$, the current flow is from OS2 to OS1. The voltages on the pins relate as follows:

$$V_{OS2} > V_{OS1} > V_{CS}$$

The opposite applies when $V_{CTLI} < 1.50V$ current flows from OS1 to OS2:

$$V_{OS2} < V_{OS1} < V_{CS}$$

Shutdown Control

The MAX8520/MAX8521 can be placed in a power-saving shutdown mode by driving $\overline{SHDN}$ low. When the MAX8520/MAX8521 are shut down, the TEC is off (OS1 and OS2 decay to GND) and supply current is reduced to 2mA (typ).

ITEC Output

ITEC is a status output that provides a voltage proportional to the actual TEC current. $V_{ITEC} = REF$ when TEC current is zero. The transfer function for the ITEC output is:

$$V_{ITEC} = 1.50 + 8 \times (V_{OS1} - V_{CS})$$

Use ITEC to monitor the cooling or heating current through the TEC. For stability, keep the load capacitance on ITEC to less than 150pF.

Applications Information

The MAX8520/MAX8521 typically drive a TEC inside a thermal-control loop. TEC drive polarity and power are regulated based on temperature information read from a thermistor or other temperature-measuring device to maintain a stable control temperature. Temperature stability of $\pm 0.01^\circ C$ can be achieved with carefully selected external components.

There are numerous ways to implement the thermal loop. Figures 1 and 2 show designs that employ precision op amps, along with a DAC or potentiometer to set the control temperature. The loop may also be implemented digitally, using a precision A/D to read the thermistor or other temperature sensor, a microcontroller to implement the control algorithm, and a DAC (or filtered-PWM signal) to send the appropriate signal to the MAX8520/MAX8521 CTLI input. Regardless of the form taken by the thermal-control circuitry, all designs are similar in that they read temperature, compare it to a set-point signal, and then send an error-correcting signal to the MAX8520/MAX8521 that moves the temperature in the appropriate direction.

PC Board Layout and Routing

High switching frequencies and large peak currents make PC board layout a very important part of design. Good design minimizes excessive EMI and voltage gradients in the ground plane, both of which can result in instability or regulation errors. Follow these guidelines for good PC board layout:

- 1) Place decoupling capacitors as close to the IC pins as possible.
- 2) Keep a separate power ground plane, which is connected to PGND1 and PGND2. PV_{DD1} , PV_{DD2} , PGND1, and PGND2 are noisy points. Connect decoupling capacitors from PV_{DD} s to PGNDs as directly as possible. Output capacitors C2 and C7 returns are connected to PGND plane.
- 3) Connect a decoupling capacitor from V_{DD} to GND. Connect GND to a signal ground plane (separate from the power ground plane above). Other V_{DD} decoupling capacitors (such as the input capacitor) need to be connected to the PGND plane.
- 4) Connect GND and PGND_ pins together at a single point, as close as possible to the chip.
- 5) Keep the power loop, which consists of input capacitors, output inductors, and capacitors, as compact and small as possible.

Smallest TEC Power Drivers for Optical Modules

- 6) To ensure high DC loop gain and minimum loop error, keep the board layout adjacent to the negative input pin of the integrator (U2 in Figure1) clean and free of moisture. Any contamination or leakage current into this node can act to lower the DC gain of the integrator, which can degrade the accuracy of the thermal loop. If space is available, it can also be helpful to surround the negative input node of the integrator with a grounded guard ring.

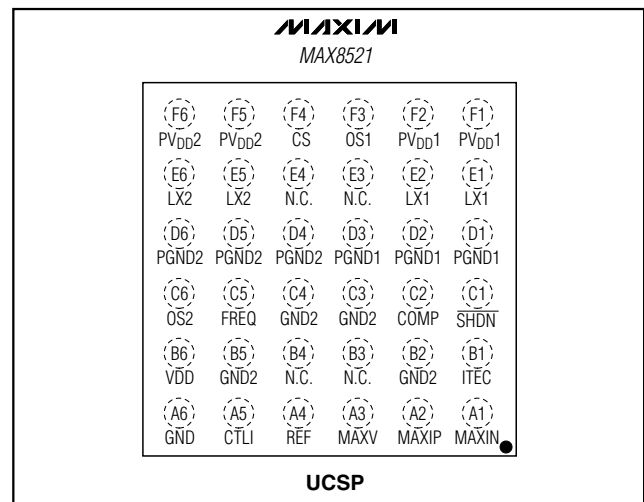
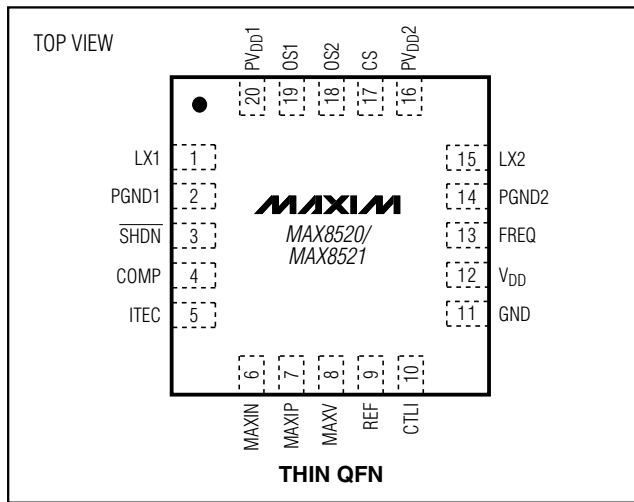
Refer to the MAX8520/MAX8521 evaluation kit for a PC board layout example.

Chip Information

TRANSISTOR COUNT: 3007

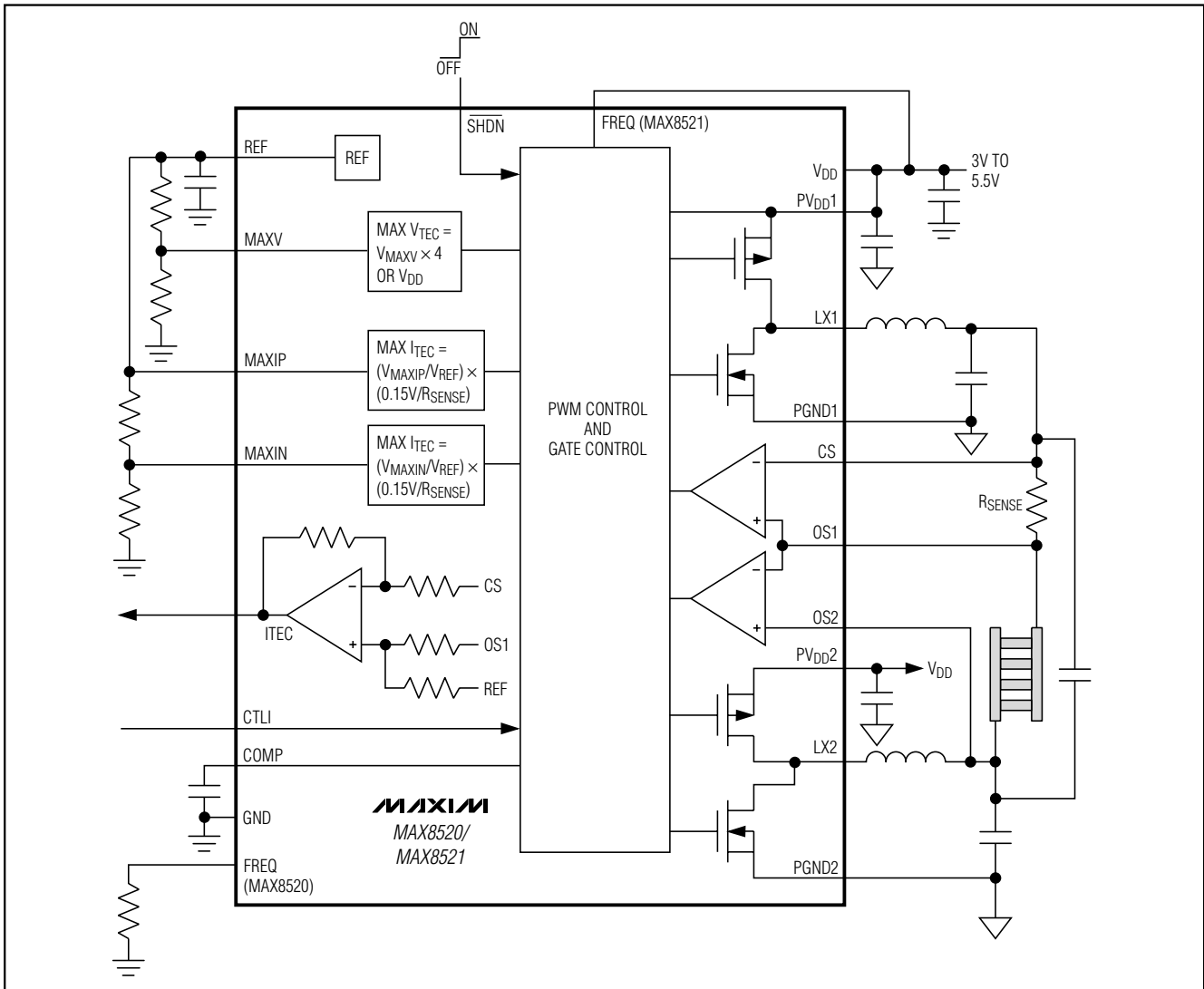
PROCESS: BiCMOS

Pin Configurations



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Functional Diagram

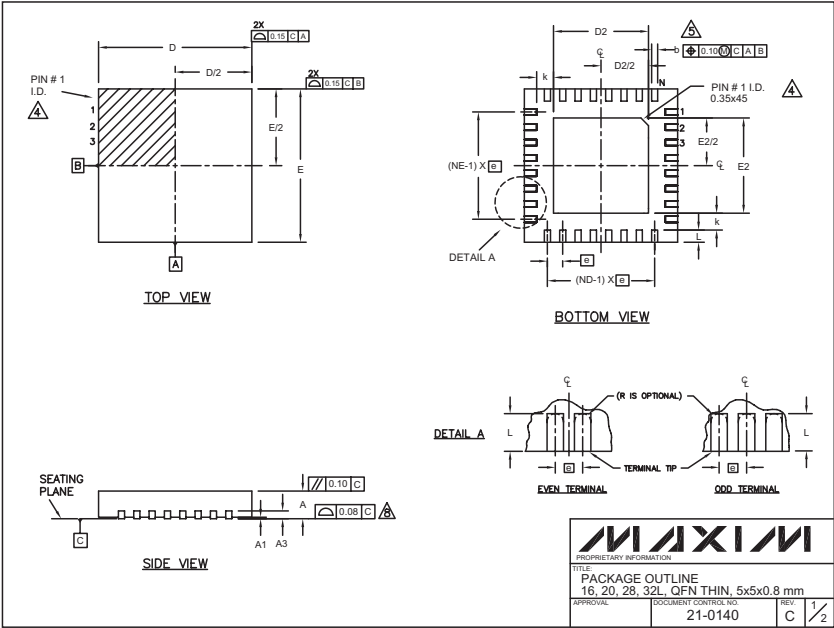


MAX8520/MAX8521

Smallest TEC Power Drivers for Optical Modules

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



COMMON DIMENSIONS												
PKG.	16L 5x5			20L 5x5			28L 5x5			32L 5x5		
SYMBOL	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80
A1	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05
A3	0.20 REF.			0.20 REF.			0.20 REF.			0.20 REF.		
b	0.25	0.30	0.35	0.25	0.30	0.35	0.20	0.25	0.30	0.20	0.25	0.30
D	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10
E	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10
e	0.80 BSC.			0.65 BSC.			0.50 BSC.			0.50 BSC.		
k	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-
L	0.45	0.55	0.65	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50
N	16			20			28			32		
ND	4			5			7			8		
NE	4			5			7			8		
JEDEC	WHHB			WHHC			WHHD-1			WHHD-2		

EXPOSED PAD VARIATIONS									
PKG. CODES	D2			E2					
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
T1655-1	3.00	3.10	3.20	3.00	3.10	3.20			
T2055-2	3.00	3.10	3.20	3.00	3.10	3.20			
T2855-1	3.15	3.25	3.35	3.15	3.25	3.35			
T2855-2	2.80	2.70	2.60	2.80	2.70	2.60			
T3255-2	3.00	3.10	3.20	3.00	3.10	3.20			

NOTES:

- DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
- ALL DIMENSIONS ARE IN MILLIMETERS; ANGLES ARE IN DEGREES.
- N IS THE TOTAL NUMBER OF TERMINALS.
- THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JEDEC 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.
- DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm FROM TERMINAL TIP.
- ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
- DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.
- COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
- DRAWING CONFORMS TO JEDEC MO220.
- WARPAGE SHALL NOT EXCEED 0.10 mm.

MAXIM

PROPRIETARY INFORMATION

TITLE: PACKAGE OUTLINE

16, 20, 28, 32L, QFN THIN, 5x5x0.8 mm

APPROVAL: 21-0140

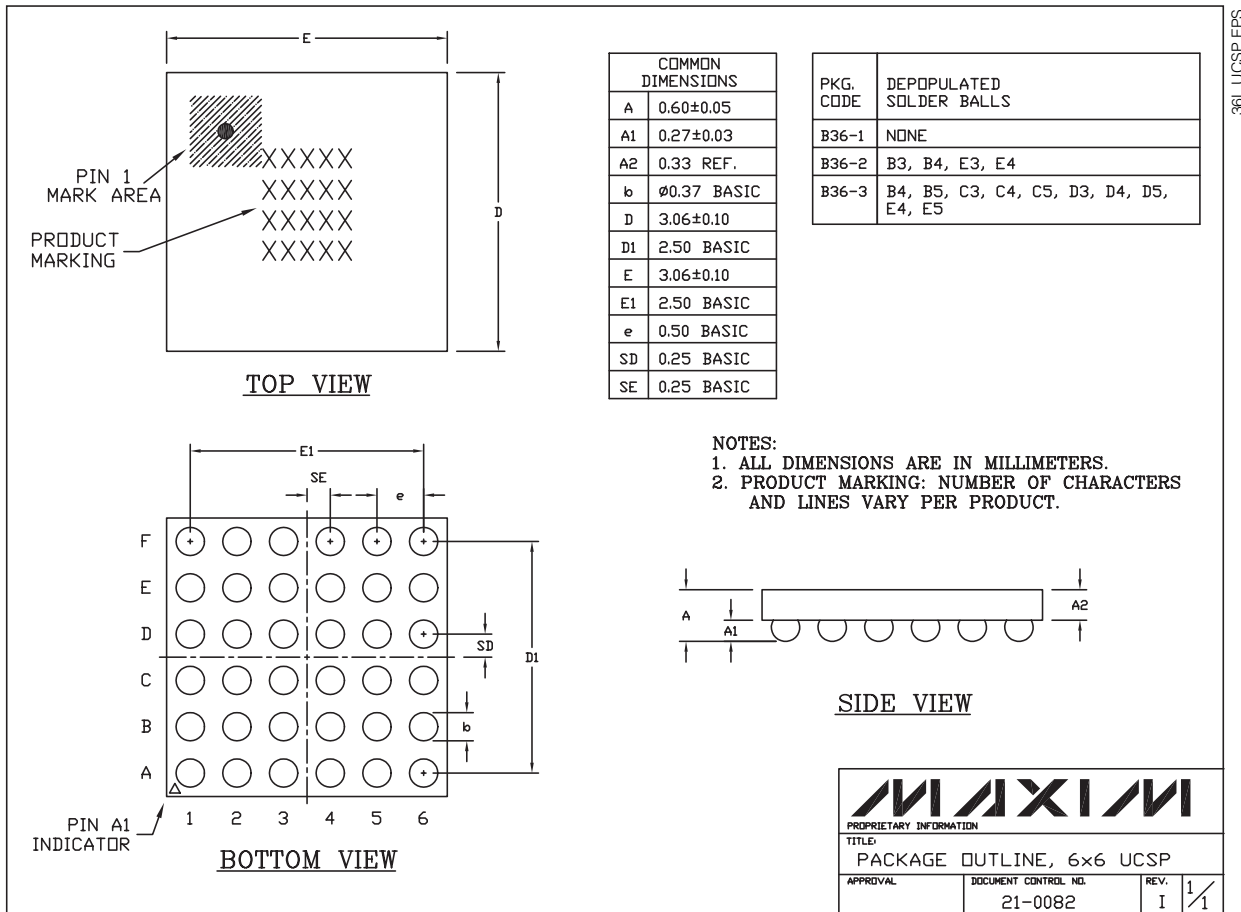
REV: C

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Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



MAX8520/MAX8521

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